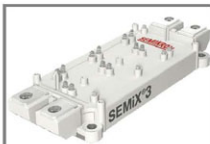


SEMIX 653GB176HDs



SEMIX® 3s

Trench IGBT Modules

SEMIX 653GB176HDs

SEMIX 653GAL176HDs

SEMIX 653GAR176HDs

Preliminary Data

Features

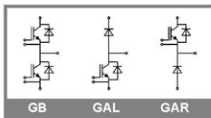
- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability
- Released for Sn-Pb and Ni-Au PCB surfaces

Typical Applications

- AC inverter drives
- UPS
- Electronic welders

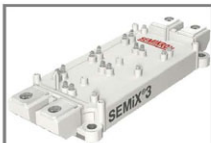
Remarks

- short circuit capability is tested @ $V_{CC}=1000V$ (all other static parameters are tested @ $V_{CC}=1200V$)



Absolute Maximum Ratings		$T_c = 25^\circ C$, unless otherwise specified		
Symbol	Conditions	Values	Units	
IGBT				
V_{CES}	$T_J = 25^\circ C$	1700	V	
I_C	$T_J = 150^\circ C$	$T_c = 25^\circ C$	620	A
		$T_c = 80^\circ C$	435	A
I_{CRM}	$I_{CRM} = 2 \times I_{Crom}$	900	A	
V_{GES}		± 20	V	
t_{psc}	$V_{CC} = 1200 V; V_{GE} \leq 20 V; T_J = 125^\circ C$ $V_{CES} < 1700 V$	10	μs	
Inverse Diode				
I_F	$T_J = 150^\circ C$	$T_c = 25^\circ C$	545	A
		$T_c = 80^\circ C$	365	A
I_{FRM}	$I_{FRM} = 2 \times I_{FRom}$	900	A	
I_{FSM}	$t_p = 10 ms; sin.$	$T_J = 25^\circ C$	2900	A
Module				
$I_{T(RMS)}$		600	A	
T_{vj}		-40 ... +150	$^\circ C$	
T_{stg}		-40 ... +125	$^\circ C$	
V_{lcol}	AC, 1 min.	4000	V	

Characteristics		$T_c = 25^\circ C$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}; I_C = 18 mA$	5,2	5,8	6,4	V
I_{CES}	$V_{GE} = 0 V, V_{CE} = V_{CES}$			0,45	mA
V_{CE0}		$T_J = 25^\circ C$	1	1,2	V
		$T_J = 125^\circ C$	0,9	1,1	V
r_{CE}	$V_{GE} = 0 V$	$T_J = 25^\circ C$	2,2	2,8	m Ω
		$T_J = 125^\circ C$	3,4	4	m Ω
$V_{CE(sat)}$	$I_{Crom} = 450 A, V_{GE} = 15 V$	$T_J = 25^\circ C_{chiplev.}$	2	2,45	V
		$T_J = 125^\circ C_{chiplev.}$	2,45	2,9	V
C_{ies}	$V_{CE} = 25, V_{GE} = 0 V$	$f = 1 MHz$	39,6		nF
C_{oes}			1,6		nF
C_{res}			1,3		nF
Q_G	$V_{GE} = -8 V \dots +15 V$		4200		nC
$t_{s(on)}$	$R_{Con} = 3,6 \Omega$	$V_{CC} = 1200V$ $I_{Crom} = 450A$	290		ns
t_r			90		ns
E_{on}	$R_{Goff} = 3,6 \Omega$	$T_J = 125^\circ C$	300		mJ
$t_{s(off)}$			975		ns
t_f			190		ns
E_{off}			180		mJ
$R_{th(j-c)}$	per IGBT			0,054	K/W



SEMiX® 3s

Trench IGBT Modules

SEMiX 653GB176HDs

SEMiX 653GAL176HDs

SEMiX 653GAR176HDs

Preliminary Data

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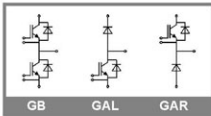
Remarks

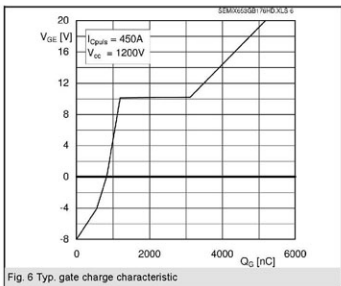
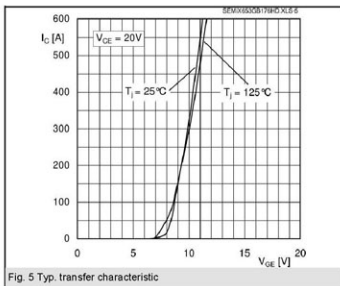
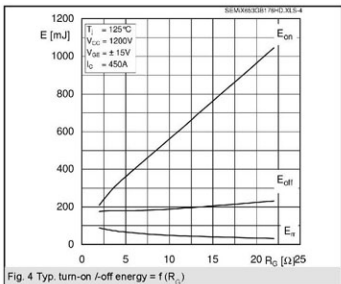
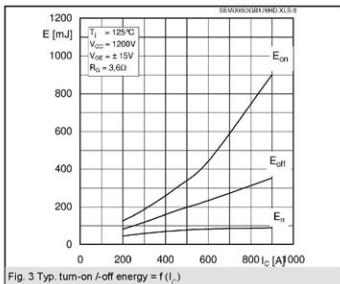
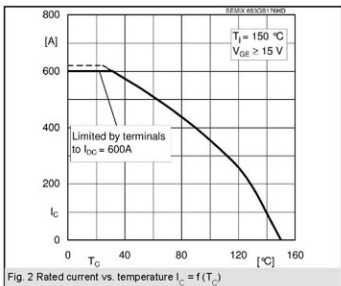
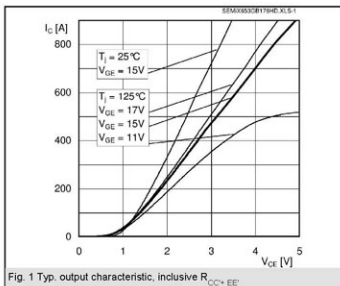
- short circuit capability is tested @ $V_{CC}=1000V$ (all other static parameters are tested @ $V_{CC}=1200V$)

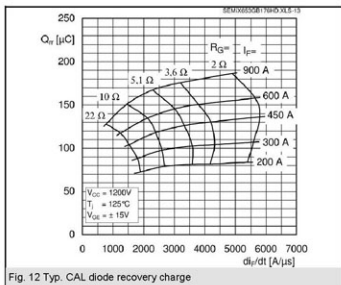
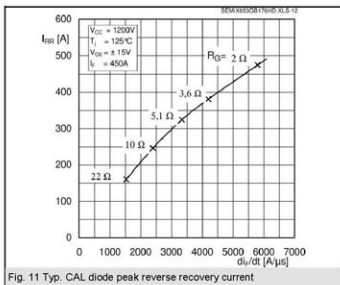
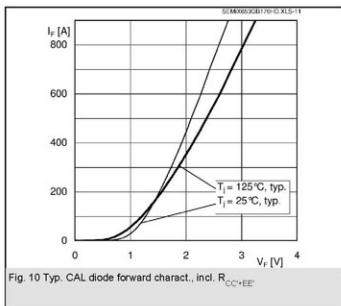
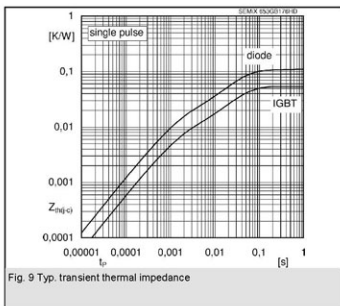
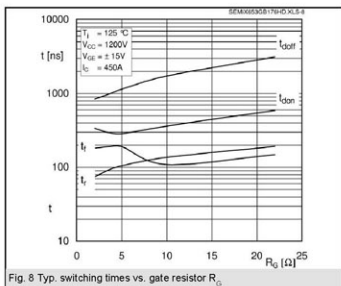
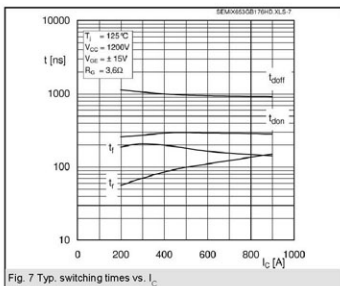
Characteristics		min.	typ.	max.	Units
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 450 A; V_{GE} = 0 V$	$T_J = 25 ^\circ C_{chiplev.}$	1,7	1,9	V
		$T_J = 125 ^\circ C_{chiplev.}$	1,7	1,9	V
V_{FO}		$T_J = 25 ^\circ C$	1,1	1,3	V
		$T_J = 125 ^\circ C$	0,9	1,1	V
r_F		$T_J = 25 ^\circ C$	1,3		mΩ
		$T_J = 125 ^\circ C$	1,8		mΩ
I_{RSM}	$I_{Fnom} = 450 A$	$T_J = 125 ^\circ C$	380		A
C_{tr}	$di/dt = 4200 A/\mu s$		130		μC
E_{tr}	$V_{GE} = -15 V; V_{CC} = 1200 V$		73		mJ
$R_{\theta(j-c)}$	per diode			0,11	K/W
Module					
L_{DE}			20		nH
R_{CC+EE}	res., terminal-chip	$T_{c380} = 25 ^\circ C$	0,7		mΩ
		$T_{c380} = 125 ^\circ C$	1		mΩ
$R_{\theta(j-a)}$	per module		0,04		K/W
M_B	to heat sink M5		3	5	Nm
M_L	to terminals M6		2,5	5	Nm
w				300	g
Temperature sensor					
R_{100}	$T_c = 100^\circ C (R_{25} = 5 k\Omega)$		0,493±5%		kΩ
$B_{100/125}$	$R(T) = R_{100} \exp[B_{100/125} (1/T - 1/T_{100})]$; $T[K]; B$		3550±2%		K

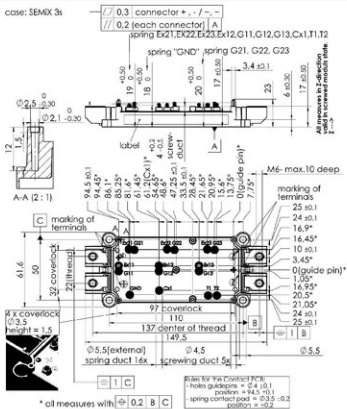
This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.









Case SEMIX 3s

